

Upcoming: June 10–14 8th Intl. Conf. on Electronic Materials, C-MRS/IUMRS; June 18–21 E-MRS Spring Meeting, E-MRS.

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313; bulletin@mrs.org.

MRS, A-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-S, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.

▼ identifies a new or revised entry this month.

See the March 2002 MRS BULLETIN for May 2002 Calendar entries.

JUNE 2002

1-6 ▼ Conf. on Cluster-Surface Interactions, *Granada, Spain*. European Science Foundation, EURESCO Office, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-3-8876-7135; fax 33-3-8836-6987; e-mail euresco@esf.org; www.esf.org/euresco.

1-6 ▼ Conf. on Fundamental Aspects of Surface Science, *Acquafredda di Maratea (Naples), Italy*. European Science Foundation, EURESCO Office, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-3-8876-7135; fax 33-3-8836-6987; e-mail euresco@esf.org; www.esf.org/euresco.

2-6 Intl. Conf. on Applications of Photonic Technology, *Quebec City, Canada*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

3-5 ▼ Conf. on Recent Advances in Flame Retardancy of Polymeric Materials, *Stamford, CT*. Business Communications Co., 25 Van Zant St., Norwalk, CT 06855; 203-853-4266; fax 202-853-0348; e-mail sales@bccresearch.com; www.bccresearch.com.

3-7 9th Intl. Conf. on Muon Spin Rotation, Relaxation, and Resonance, *Williamsburg, VA*. C.E. Stronach, Conf. Chair, Physics Dept., P.O. Box 9325, Virginia State Univ., Petersburg, VA 23806; 804-524-5915; fax 804-524-5439; e-mail cstronac@vsu.edu; http://muon.physics.wm.edu/~musr2002.

3-7 11th Intl. Conf. on Metal Organic Vapor Phase Epitaxy, *Berlin, Germany*. IC MOVPE XI Conf. Office, TU Berlin Servicegesellschaft mbH, c/o Technische Univ. Berlin, Steinplatz 1, D-10623 Berlin, Germany; fax 49-30-314-24087; e-mail office@icmovpe-2002.de; www.icmovpe-2002.de.

4-5 ▼ Designing Power Electronics for Electro-Magnetic Compatibility, *Washington, DC*. Intertech, 19 Northbrook Office Park, Portland, ME 04105; 207-781-9800; fax 207-781-2150; e-mail info@intertechusa.com; www.intertechusa.com/power.html.

5-8 4th Intl. Conf. on Mechanics and Materials in Design, *Nagoya, Japan*. H. Fujii, Dept. of Mechanical Engineering, Gifu Univ., Japan; e-mail fujiih@mech.gifu-u.ac.jp.

8-13 39th Clay Minerals Society Annual Meeting, *Boulder, CO*. K. Nagy, Dept. of Geological Sciences, Univ. of Colorado, Boulder, CO 80309; 303-492-6187; fax 303-492-2602; e-mail kathryn.nagy@colorado.edu; www.colorado.edu/geolsci/cms.

9-13 Conf. on Nanostructured Advanced Magnetic Materials, *Irsee, Germany*. United Engineering Foundation, 27th Floor, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

10-12 4th Intl. Conf. on Materials for Microelectronics and Nanoengineering, *Espoo, Finland*. L. Bromley, Conferences and Events, IOM Communications; 44-20-7451-7302; fax 44-20-7839-2289; e-mail lisa_bromley@materials.org.uk.

10-13 ▼ 13th AeroMat Conf., *Orlando, FL*. ASM Intl., 9639 Kinsman Rd., Materials Park, OH 44073-0002; 440-338-5151; fax 440-338-4634; e-mail cust-srv@asminternational.org; www.asminternational.org.

10-14 8th Intl. Conf. on Electronic Materials, *Xi'an, China*. J. Cheng; 86-10-6894-4280; fax 86-10-6842-8640; e-mail cmrsec@public.bta.net.cn; www.c-mrs.org.cn/icem2002. C-MRS/IUMRS.

16-18 European IMAPS Symposium, *Cracow, Poland*. Intl. Microelectronics and Packaging Society, 611 2nd St. NE, Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

16-20 Intl. Cryogenic Materials Conf., *Xi'an, China*. Y. Feng, Northwest Inst. for Non-ferrous Metal Research, P.O. Box 51, Xi'an, Shaanxi 710016, China; 86-29-623-1079; fax 86-29-623-1103; e-mail smrc@pub.xaonline.com.

16-21 6th Intl. Conf. on Nanostructured Materials, *Orlando, FL*. K. Finnerty, Conf. Secretary, Dept. of Ceramic and Materials Engineering, Rutgers Univ., 607 Taylor Rd., Piscataway, NJ 08854; 732-445-2245; fax 732-445-5977; e-mail kfinnert@rci.rutgers.edu; www.nano2002.com.

16-21 ▼ Gordon Research Conf. on Energetic Materials, *Tilton, NH*. Gordon Research Conferences, 3071 Rt. 138, Kingston, RI 02881; 401-783-4011; fax 401-783-7644; e-mail grc@grc.org; www.grc.org.

16-21 Powder Metallurgy and Particulate Materials World Congress, *Orlando, FL*. S. Leatherman, Metal Powder Industries Federation, 105 College Rd. East, Princeton, NJ 08540-6692; 609-452-7700; fax 609-987-8523; e-mail leatherm@mpif.org; www.mpif.org.

17-19 ▼ 9th Intl. Seminar on the Technology of Inherently Conductive Polymers, *Monterey, CA*. M. Aldissi, Advanced Polymer Courses, 200 9th Ave. North, Ste. 100, Safety Harbor, FL 34695; 727-723-3006; fax 727-723-3007; e-mail fractals@infobridge.com; www.conductivepolymers.com.

17-20 1st Intl. Conf. on Multiscale Materials Modeling, *London, UK*. MMM Local Organising Committee, Dept. of Materials, Queen Mary, Univ. of London, London E1 4NS, UK; 44-20-7882-5159; fax 44-20-8981-9804; e-mail x.guo@qmw.ac.uk; www.multiscalemodelling.com.

18-20 ▼ Conf. on Solid-Liquid Separation, *Falmouth, UK*. B. Wills, Minerals Engineering Intl., 18 Dracaena Ave., Falmouth, Cornwall TR11 2EQ, UK; 44-1326-312236; fax 44-1326-318352; e-mail bwills@min-eng.com; www.min-eng.com/s102.html.

18-21 E-MRS Spring Meeting, *Strasbourg, France*. E-MRS, 23 rue du Loess, B.P. 20, 67037 Strasbourg Cedex 02, France; 33-3-8810-6372; fax 33-3-8810-6343; e-mail emrs@phase.c-strasbourg.fr; www.emrs.c-strasbourg.fr. E-MRS.

19-21 5th European Workshop on Low-Temperature Electronics, *Grenoble, France*. WOLTE-5, LPCS-IMEP, ENSERG, B.P. 257, 38016 Grenoble Cedex 1, France; fax 33-476-85-60-70; e-mail balestra@enserg.fr.

19-21 IMAPS Advanced Technology Workshop on Passive Integration, *Ogunquit, ME*. Intl. Microelectronics and Packaging Society, 611 2nd St. N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

22-28 Intl. Quantum Electronics Conf., collocated with Conf. on Lasers, Applications, and Technologies, *Moscow, Russia*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

23-26 Intl. Conf. on Thermo-mechanical Processing, *Sheffield, UK*. Thermomechanical Processing: Mechanics, Microstructure, and Control, c/o IMPPETUS Admin. Office, Univ. of Sheffield, Sir Frederick Mappin Bldg., Mappin St., Sheffield S1 3JD, UK; 44-114-222-6018; fax 44-114-222-6015; e-mail tpmmc@sheffield.ac.uk; http://dyn052176.shef.ac.uk/conference_2002.

23-27 6th Intl. Conf. on Computer Simulation of Radiation Effects in Solids, *Dresden, Germany*. COSIRES2002, c/o Forschungszentrum Rossendorf e.V., Inst. of Ion Beam Physics and Materials Research, P.O. Box 510119, 01314 Dresden, Germany; fax 48-351-260-3285; e-mail COSIRES2002@fz-rossendorf.de; www.fz-rossendorf.de/FWI/COSIRES2002.

23-27 American Conf. on Neutron Scattering, *Knoxville, TN*. R.M. Briber, Dept. of Materials and Nuclear Engineering, 2100 Marie Mount Hall, Univ. of Maryland, College Park, MD 20742-7531; 301-405-7313; fax 301-314-9601; e-mail rbriber@eng.umd.edu; www.sns.gov/acns.

23-28 11th Intl. Meeting on Lithium Batteries, *Monterey, CA*. IMLB 11 Conf. Secretariat, c/o The Electrochemical Society, Inc., 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org/meetings/011/imlb11.html.

24-26 60th Annual Device Research Conf., *Santa Barbara, CA*. The Minerals, Metals & Materials Society, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail mtgsrv@tms.org; www.tms.org/Meetings/Specialty/DRC/2002/DRC-2002-Home.html.

24-26 AAPS Natl. Biotechnology Conf., *San Diego, CA*. American Assoc. of Pharmaceutical Scientists, 2107 Wilson Blvd., Ste. 700, Arlington, VA 22201-3046; 703-243-2800; fax 703-243-9532; e-mail meetings@aaps.org; www.aaps.org.

24-26 IMAPS Topical Workshop on Flip Chip Technology, *Austin, TX*. Intl. Microelectronics and Packaging Society, 611 2nd St. N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

24-27 Natl. Space and Missile Materials Symposium, *Colorado Springs, CO*. NSMMS, Anteon Corp., 5100 Springfield St., Ste. 509, Dayton, OH 45431-1264; fax 937-253-2296; e-mail mkubal@anteon.com; www.usasymposium.com.

24-28 ▼ 7th Intl. Conf. on Nanometer-Scale Science and Technology, and 21st European Conf. on Surface Science, *Malmö, Sweden*. Conf. Secretariat, NANO-7/ECOSS-21, Solid State Physics, Lund Univ., Box 118, S-221 00 Lund, Sweden; 46-46-222-9586; fax 46-46-222-3637; e-mail nano-ecoss.2002@tf.lth.se; www.malmo-congress.com/nano-ecoss.html.

26-28 Electronic Materials Conf., *Santa Barbara, CA*. TMS Meetings Services, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/meetings.

29-4 ▼ Conf. on Future Perspectives of Superconducting Josephson Devices, *Pommersfelden, Germany*. European Science Foundation, EURESCO Office, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-3-8876-7135; fax 33-3-8836-6987; e-mail euresco@esf.org; www.esf.org/euresco.

30-5 3rd Intl. Alloy Conf., *Estoril (Lisbon), Portugal*. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

JULY 2002

1-3 World Textile Conf.: Textile Engineering at the Dawn of a New Millennium, *Bruges, Belgium*. 32-9-2645750; fax 32-9-2645846; e-mail Sylvie.Bauwens@rug.ac.be.

1-5 Conf. on Coatings Science and Technology, *Athens, Greece*. Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 914-255-0757; fax 914-255-0978; e-mail info@ims-np.org; http://ims-np.org.

1-5 Intl. Conf. on Fuel Cells, *Lucerne, Switzerland*. European Fuel Cell Forum, P.O. Box 99, CH-5452 Oberrohrdorf, Switzerland; 41-56-496-7292; fax 41-56-496-4412; e-mail info@efcf.com; www.efcf.com.

3-5 ▼ 6th Mechanical Components and Materials Technology Expo, *Tokyo, Japan*. J.A. Go, M-Tech Show Mgmt. Office; 81-3-3349-8506; fax 81-3-3345-7929; e-mail go@reedexpo.co.jp; www.reedexpo.co.jp/m-tech.

7-11 47th Annual SPIE Meeting, *Seattle, WA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

7-12 7th Intl. Workshop on Positron and Positronium Chemistry, *Knoxville, TN*. S. Lantz, PPTC, Oak Ridge Natl. Lab., P.O. Box 2008, M.S. 6142, Oak Ridge, TN 37831; 865-574-4882; fax 865-574-8363; e-mail Sharon Lantz <lantzsl@ornl.gov>; www.ornl.gov/ppc.

8-12 13th Intl. Conf. on Internal Friction and Ultrasonic Attenuation in Solids, and 1st Scientific Exhibition on Mechanical Spectroscopy Equipment, *Bilbao, Spain*. J. San Juan, Dept. Física de la Materia Condensada, Facultad de Ciencias, Univ. del País Vasco, UPV-EHU, Apdo. 644-48080, Bilbao, Spain; 34-94-601-2478; fax 34-94-464-8500; e-mail icifuas@lg.ehu.es; http://icifuas.ehu.es.

11-12 Conf. on Industry-University Partnership in Materials Engineering, *London, UK*. D. Greenaway, Conf. and Events, IOM Communications; 44-20-7451-7324; fax 44-20-7839-2289; e-mail Doreen_Greenaway@materials.org.uk; www.materials.org.uk/iomevents/industry-univ.

14-18 13th Intl. Symposium on Transport Phenomena, *Victoria, BC, Canada*. S. Dost, ISTEP-13, Dept. of Mechanical Engineering, Univ. of Victoria, Victoria, BC, Canada V8W 3P6; 250-721-8898; fax 250-721-6294; e-mail istp13@uvic.ca; www.istp13.uvic.ca.

14-19 10th Intl. Conf. on the Physics and Chemistry of Ice, *St. John's, Newfoundland, Canada*. Conf. Office, Rm. 315 Hatcher House, Memorial Univ. of Newfoundland, St. John's, NF Canada A1B 3P7; 709-737-7657; fax 709-737-3520; e-mail Stephen.Jones@nrc.ca; www.housing.mun.ca/conf/pci.

14-19 ▼ 29th Annual Review of Progress in Quantitative Non-destructive Evaluation, *Bellingham, WA*. L. Poore; 515-294-6770; fax 515-294-7771; e-mail qnde3@cnde.iastate.edu; www.cnde.iastate.edu/qnde/.

14-19 CIMTEC Intl. Conf. on Materials and Technologies: 10th Intl. Ceramics Congress and 3rd Forum on New Materials, *Florence, Italy*. CIMTEC 2002 Secretariat, P.O. Box 174, 48018 Faenza, Italy; 39-546-22461; fax 39-546-664138; www.dinamica.it/cimtec.

14-19 Conf. on Polymer Colloids: Preparation and Properties of Aqueous Polymer Dispersions, *Irsee, Germany*. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.uefoundation.org.

14-19 ▼ Gordon Research Conf. on Thin Film Mechanical Behavior, *Waterville, ME*. Gordon Research Conferences, 3071 Rt. 138, Kingston, RI 02881; 401-783-4011; fax 401-783-7644; e-mail grc@grc.org; www.grc.org.

14-25 3rd Intl. Wilhelm and Else Heraeus Summerschool: Photonic Crystals, *Wittenberg, Germany*. R. Wehrspohn, Max-Planck Inst. für Mikrostrukturphysik, Weinberg 2, 06108 Halle, Saale, Germany; 49-345-558-2726; fax 49-345-551-1223; e-mail wehrspoh@mpi-halle.de; www.photonische-kristalle.de/summerschool.

15-19 11th Intl. Congress on Plasma Physics, *Sydney, Australia*. I. Falconer, Conf. Secretary, School of Physics, Univ. of Sydney, Sydney NSW 2006, Australia; 61-2-9351-2599; fax 61-2-9692-0923; e-mail i.falconer@physics.usyd.edu.au; www.ise.canberra.edu.au/ICPP2002.

17-19 Intl. Conf. on Smart Materials, Structures, and Systems, *Bangalore, India*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

21-26 4th World Congress on Particle Technology, *Sydney, Australia*. J. Hatte, Conf. Coordinator, ICMS Australasia Pty Ltd., Level 6, 2 Bridge St., Sydney NSW 2000, Australia; 61-2-9241-1478; fax 61-2-9251-3552; e-mail josie@icmsaust.com.au; www.wcpt4.com.

21-26 8th Intl. Conf. on New Diamond Science and Technology, *Melbourne, Australia*. B. Hewitt, Conf. Mgmt., Old Physics Bldg., Univ. of Melbourne, Parkville 3010, Victoria, Australia; 61-3-8344-6389; fax 61-3-8344-6122; e-mail icndst-8@unimelb.edu.au; www.conferences.unimelb.edu.au/icndst-8.

21-26 ▼ Gordon Research Conf. on Laser Interactions with Materials, *Andover, NH*. Gordon Research Conferences, 3071 Rt. 138, Kingston, RI 02881; 401-783-4011; fax 401-783-7644; e-mail grc@grc.org; www.grc.org.

22-25 Intl. Workshop on Nitride Semiconductors, *Aachen, Germany*. IWN 2002 Secretariat, Forschungszentrum Jülich GmbH, Conf. Service, 52425 Jülich, Germany; 49-24-6161-3833; fax 49-24-6161-5333; e-mail iwn2002@fz-juelich.de; www.fz-juelich.de/iwn2002.

22-26 Intl. Conf. on Solvo-Thermal Reactions, *East Brunswick, NJ*. R.E. Riman, ICSTR 2002 Executive Committee, Dept. of Ceramic and Materials Engineering, College of Engineering, Rutgers Univ., 607 Taylor Rd., Piscataway, NJ 08854-8065; 732-445-4946; fax 732-445-6262; e-mail riman@rci.rutgers.edu; www.ICSTR.rutgers.edu.

24-4 NATO Advanced Study Inst. on Synthesis, Functional Properties, and Applications of Nanostructures, *Crete, Greece*. T. Tsakalakos, Dept. of Ceramic and Materials Engineering, College of Engineering, Rutgers Univ., 607 Taylor Rd., Piscataway, NJ 08854; 732-445-2888; fax 732-445-3229; e-mail tsakalak@rci.rutgers.edu; http://web.rutgers.edu/nanostructures.

29-2 26th Intl. Conf. on the Physics of Semiconductors, *Edinburgh, Scotland*. Conf. Dept., ICPS2002, Inst. of Physics, 76 Portland Place, London W1B 1NT, England; 44-20-7470-4800; fax 44-20-7470-4900; www.icps2002.org.

29-2 51st Denver X-Ray Conf., *Colorado Springs, CO*. D. Flaherty, Conf. Coordinator, Intl. Centre for Diffraction Data, 12 Campus Blvd., Newtown Square, PA 19073-3273; 610-325-9814; fax 610-325-9823; e-mail dxc@icdd.com; www.dxcicdd.com.

AUGUST 2002

1-2 Intl. Workshop on Processing and Applications of Superconductors, *Gallatinburg, TN*. Materials Research Society, 506 Keystone Dr., Warendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

4-8 14th American Conf. on Crystal Growth and Epitaxy, *Seattle, WA*. T. Gentile, Conf. Secretariat, P.O. Box 3233, Thousand Oaks, CA 91359-0233; 805-492-7047; fax 805-492-4062; e-mail aacg@lafn.org; www.crystalgrowth.org.

4-8 ▼ NATO Advanced Research Workshop on Nanostructured Materials and Coatings for Biomedical and Sensor Applications, *Kiev, Ukraine*. Y. Gogotsi, Drexel Univ., Dept. of Materials Engineering, 3141 Chestnut St., Philadelphia, PA 19104; 215-895-6446; fax 215-895-6760; e-mail gogotsi@drexel.edu; http://nano.materials.drexel.edu/natoarw.html.

4-9 Applied Superconductivity Conf.®, *Houston, TX*. Centennial Conferences, 4800 Baseline Rd., Ste. A-112, Boulder, CO 80303; 303-499-2299; fax 303-499-2599; e-mail asc@centennialconferences.com; www.ascinc.org.

4-9 ▼ Gordon Research Conf. on High-Temperature Materials, Processing, and Diagnostics, *Dover, ME*. Gordon Research Conferences, 3071 Rt. 138, Kingston, RI 02881; 401-783-4011; fax 401-783-7644; e-mail besmanntm@ornl.gov; www.grc.org. **Endorsed.**

4-9 ▼ Gordon Research Conf. on Nanostructure Fabrication, *Tilton, NH*. Gordon Research Conferences, 3071 Rt. 138, Kingston, RI 02881; 401-783-4011; fax 401-783-7644; e-mail grc@grc.org; www.grc.org.

11-14 ▼ Conf. of Metallurgists, Metallurgical and Materials Technologies, *Montreal, Canada*. MetSoc, 3400 de Maisonneuve Blvd. West, Ste. 1210, Montreal, Quebec, H3Z 3B8, Canada; 514-939-2710; fax 514-939-9160; e-mail metsoc@cim.org; www.metsoc.org/conferences/com2002/default.asp.

18-21 Intl. Workshop on Nanostructures for Electronics and Optics, *Dresden, Germany*. NEOP, Research Ctr. Rossendorf, Inst. of Ion Beam Physics and Materials Research, P.O.B. 51 01 19, Dresden 01314, Germany; fax 49-351-260-3285; e-mail info@NEOP.de; www.NEOP.de.

18-23 Intl. Conf. on Electro-phoretic Deposition: Fundamentals and Applications, *Banff, Canada*. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.uefoundation.org.

20-27 23rd Intl. Conf. on Low-Temperature Physics, *Hiroshima, Japan*. Japan Convention Services, Inc., LT23, Nippon Press Ctr., Bldg., 2-2-1, Uchisaiwaicho, Chiyodaku, Tokyo 100-0011, Japan; 81-3-3508-1214; e-mail lt23@convention.co.jp; www.issp.u-tokyo.ac.jp/lt23.

25-28 8th Electroceramics Conf., *Rome, Italy*. E. Di Bartolomeo, Dip. Scienze e Tecnologie Chimiche, Univ. di Roma Tor Vergata; Via della Ricerca Scientifica 1, 00133 Roma, Italy; fax 39-06-7259-4328; e-mail electroceram@stc.uniroma2.it; www.uniroma2.it/eventi/electroceramics. **Endorsed.**

25-29 Conf. on Fluid Particle Interactions, *Barga, Italy*. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.uefoundation.org.

25-30 11th Intl. Conf. on Rapidly Quenched and Metastable Materials, *Oxford, UK*. P. Schumacher, Dept. of Materials, Oxford Univ., Parks Rd., Oxford OX1 3PH, UK; 44-1234-378862; fax 44-1234-376219; e-mail rq11@materials.ox.ac.uk; www.materials.ox.ac.uk/rq11.

25-30 ▼ Conf. on Nanoelectronics and Nanotechnologies, *Wolin Island, Poland*. WSEAS; www.wseas.org/conferences/2002/miedzylodroje/nr/.

26-28 ▼ 2nd IEEE Conf. on Nanotechnology, *Washington, DC*. IEEE Nanotechnology, 2025 M St., Ste. 800, Washington, DC 20036; 202-331-2000; fax 202-331-011; http://ewh.ieee.org/tc/nanotech/nano2002/.

28-31 2nd Intl. Mould & Die Making and Manufacturing Technology Exhibition for Asia, *Hong Kong*. Business and Industrial Trade Fairs Ltd., Unit 1223, HITEC, 1 Trademart Dr., Kowloon Bay, Hong Kong; 852-2865-2633; fax 852-2866-1770; e-mail enquiry@bitf.com.hk.

SEPTEMBER 2002

1-6 ▼ 4th European Computational Chemistry Conf., *Assisi, Italy*. A. Laguna, Dipartimento di Chimica, Via Elce di sotto 8, 06123 Perugia, Italy; 39-755-855-527; fax 39-755-855-606; www.chm.unipg.it/chimgen/mb/cong/EUCO-CC4/index.html.

1-6 ▼ 13th Intl. Conf. on Ion Beam Modification of Materials, *Kobe, Japan*. Secretariat-IBMM2002, Y. Yuba, Div. of Advanced Electronics and Optical Science, Graduate School of Engineering Science, Osaka Univ., 1-3 Machikaneyama-cho, Toyonaka, Osaka 560-8531, Japan; 81-6-6850-6301; fax 81-6-6850-6341; e-mail ibmm2002@nano.ee.osaka-u.ac.jp; www.nano.ee.osaka-u.ac.jp/ibmm2002/

4-5 Conf. on 42 Volt Automotive Systems: Exploring the Market and Opportunities in Bringing 42 Volts to Market, *Cleveland, OH*. B. Santos, Intertech Conferences, 19 Northbrook Office Park, Portland, ME 04105; 207-781-9800; fax 207-781-2150; e-mail bsantos@intertechusa.com; www.intertechusa.com/42volts.html.

4-6 35th Intl. Symposium on Microelectronics, *Denver, CO*. Intl. Microelectronics And Packaging Society, 611 2nd St. NE, Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

7–12 ▼ Conf. on Computational Biophysics: Integrating Theoretical Physics and Biology, *San Feliu de Guixols, Spain*. European Science Foundation, EURESCO Office, 1 quai Leyaz-Marnésia, 67080 Strasbourg cedex, France; 33-3-8876-7135; fax 33-3-8836-6987; e-mail euresco@esf.org; www.esf.org/euresco.

8–12 6th Intl. Meeting on Magnetic Resonance in Porous Media, *Ulm, Germany*. www.uni-ulm.de/nmr/mrpm6/early_notification.htm.

9–13 8th Intl. Conf. on Plasma and Surface Engineering, *Garmisch-Partenkirchen, Germany*. Arbeitskreis Plasmaoberflächentechnologie (PISE Germany), c/o. K. Reichel, VDI-Technologiezentrum, Graf-Recke-Str. 84, D-40239 Düsseldorf, Germany; 49-211-6214-567; fax 49-211-6214-484; e-mail akplasma@vdi.de; www.akplasma.org.

10–12 Intl. Conf. on Design and Nature: Comparing Design in Nature with Science and Engineering, *Udine, Italy*. G. Cossutta, Conf. Secretariat, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail gcossutta@wessex.ac.uk; www.wessex.ac.uk.

10–13 ▼ Conf. on Structural Materials Technology: NDE/NDT for Highways and Bridges Topical, *Cincinnati, OH*. K. Wise, American Society for Nondestructive Testing, 1711 Arlington Lane, P.O. Box 28518, Columbus, OH 43228-0518; 614-274-6003; fax 614-274-6899; www.asnt.org.

10–14 ▼ Intl. Conf. on Polycrystalline Semiconductors, *Nara City, Japan*. T. Sameshima, Tokyo Univ. Agriculture and Technology, 2-24-16 Nakamachi, Koganei, Tokyo 184-8588, Japan; phone and fax 81-423-88-7109; e-mail tsamesim@cc.tuat.ac.jp; www.tuat.ac.jp/~polys02.

11–13 ▼ Nano and Giga Challenges in Microelectronics: Research Opportunities in Russia, *Moscow, Russia*. www.AtomicScaleDesign.NET/moscow/.

16–19 ▼ 2nd EuroAsian Conf. on Nuclear Science and Applications, *Almaty, Kazakhstan*. T. Kvochkin; 7-3272-546-504; e-mail kvochn@inp.kz.

16–20 Intl. Conf. on Shot Peening, *Garmisch-Partenkirchen, Germany*. P. Schepp, Deutsche Gesellschaft für Materialkunde e.V., Hamburger Allee 26, D-60486 Frankfurt, Germany; 49-69-7917-750; fax 49-69-7917-733; e-mail shot-peening@dgm.de; www.dgm.de/shot-peening.

17–20 **A First Materials Forum on Future Sustainable Technologies**, *Augsburg, Germany*. e-mail stritzker@physik.uni-augsburg.de. **E-MRS/MRS**.

22–26 ▼ Conf. on Advanced Materials and Processes for Gas Turbines, *Copper Mountain, CO*. United Engineering Foundation Conferences, 27th Floor, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

22–26 **3rd World Congress on Microwave and Radio Frequency Processing**, *Sydney, Australia*. e-mail mrf2002@tourhosts.com.au; www.microwave-rf.org. **Endorsed**.

24–27 3rd World Congress on Emulsions, *Lyon, France*. CME, 50 Place Marcel Pagnol, 92100 Boulogne-Billancourt, France; 33-147-617-689; fax 33-147-617-465; e-mail alain.lecroller@wanadoo.fr; www.cme-emulsion.com.

24–28 7th Intl. Conf. on Semi-Solid Processing of Alloys and Composites, *Tsukuba, Japan*. M. Kiuchi, 7th S2P Secretariat, KILAMETEC, Rm. 703, 5-30-1 Shiba, Minato-ku, Tokyo 108-0014, Japan; fax 81-3-5730-3136; e-mail s2p7@jstp.or.jp; www.s2p7@jstp.or.jp.

25–26 ▼ Conf. on Fuel Cells Science and Technology: Scientific Advances in Fuel Cell Systems, *Amsterdam, The Netherlands*. C. Norris, 51 Kestrel Way, Wokingham, Berkshire RG41 3HA, UK; 44-118-377-4696; fax 44-118-377-4696; e-mail claire@eventive.org.uk; www.fuelcelladvances.com.

26–27 10th Intl. Activated Carbon Conf., *Pittsburgh, PA*. Professional Analytical and Consulting Services, Inc., 409 Meade Dr., Coraopolis, PA 15108-9616; 724-457-6576; e-mail HNPacs@aol.com; www.pacs-labs.com.

29–2 18th Laser Science Conf., *Orlando, FL*. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

29–2 IMAPS Nordic Conf., *Stockholm, Sweden*. Intl. Microelectronics and Packaging Society, 611 2nd St. N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; e-mail info@imapsnordic.org; www.imapsnordic.org.

30–2 Materials Week Congress, and 5th Intl. Trade Fair for Materials Applications, Surface Technology, and Product Engineering, *Munich, Germany*. E. Richter-Maierhofer, Materialica, Messe München GmbH, 81823 München, Germany; 49-89-949-20650; fax 49-89-949-20659; e-mail richter-maierhofer@messe-muenchen.de; www.materialica.de.

OCTOBER 2002

1–3 Advanced Metallization Conference 2002, San Diego, CA. Continuing Education in Engineering, UC Berkeley Extension, 1995 University Ave., Berkeley, CA 94720-7010; 510-642-4151; fax 510-642-6027; e-mail course@unx.berkeley.edu; www.unex.berkeley.edu/eng/metal.

1–4 ▼ 8th Russian Conf. on Gallium Arsenide and III-V Group Related Compounds, *Tomsk, Russia*. Organizing Committee of <GaAs-2002>, Siberian Physical Technical Inst., pl. Novosobornaya, 1, 634050, Tomsk, Russia; fax 3822-533-034; e-mail brudnyi@ic.tsu.ru; http://phys.tsu.ru/eng/GaAs-2002.

1–4 54th Pacific Coast Regional and ACerS Basic Science Div. Meeting, *Seattle, WA*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 619-899-6109; e-mail customersrvc@acers.org; www.ceramics.org.

4–5 APS Four Corners Section Meeting, *Salt Lake City, UT*. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

6–10 TMS Fall Meeting, *Columbus, OH*. TMS Programming Dept., 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail ckobert@tms.org; www.tms.org.

7–10 ▼ 13th Intl Federation for Heat Treatment and Surface Engineering Congress, and ASM Surface Engineering Congress, *Columbus, OH*. ASM Intl., 9639 Kinsman Rd., Materials Park, OH 44073-0002; 440-338-5151; fax 440-338-4634; e-mail cust-srv@asminternational.org; www.asminternational.org.

7–10 ▼ ASM Materials Solutions Conf., *Columbus, OH*. ASM Intl., 9639 Kinsman Rd., Materials Park, OH 44073-0002; 440-338-5151; fax 440-338-4634; e-mail cust-srv@asminternational.org; www.asminternational.org.

8–11 IMAPS Topical Workshop on Optoelectronics Packaging and Micro-Optoelectromechanical Systems, *Bethlehem, PA*. Intl. Microelectronics and Packaging Society, 611 2nd St. N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

10–12 APS Texas Section Meeting, *Brownsville, TX*. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

11–12 APS New York Section Fall Meeting, *Syracuse, NY*. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

13–16 ▼ 17th Natl. Educators' Workshop, *San Jose, CA*. J. Jacobs, School of Science and Technology, Norfolk State Univ., 700 Park Ave., Norfolk, VA 23504-8060; 757-823-8109; fax 757-823-8215; e-mail dplacaire@nsu.edu; http://MST-Online.nsu.edu/new.

13–16 ACerS Glass and Optical Materials Div. Meeting, *Pittsburgh, PA*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 619-899-6109; e-mail customersrvc@acers.org; www.ceramics.org.

14–17 21st Intl. Congress on Applications of Lasers and Electro-Optics, *Scottsdale, AZ*. B. Cohen, Laser Inst. of America, 13501 Ingenuity Dr., Ste. 128, Orlando, FL 32826; 407-380-1553; fax 407-380-5588; e-mail bcohen@laserinstitute.org; www.icaleo.org.

14–18 ▼ 13th Intl. Conf. on Ternary and Multinary Compounds, *Paris, France*. D. Lincot, Lab. d'Electrochimie et de Chimie Analytique (CNRS UMR 7575), Ecole Nationale Supérieure de Chimie de Paris, France. 33-155-426-377; fax 33-144-276-750; e-mail lincot@ext.jussieu.fr; www.enscp.jussieu.fr/ICTMC13.

15–18 55th Gaseous Electronics Conf., *Minneapolis, MN*. e-mail gec@me.umn.edu; www.me.umn.edu/gec.

16–18 7th Spanish Natl. Materials Conf., *Madrid, Spain*. O. Sanz, Sociedad Española de Cerámica y Vidrio; 34-918-711-800; fax 34-918-700-500; www.secv.es/madridmateriales2002.

16–18 ACerS Refractory Ceramics Division and Pittsburgh Section Fall Meeting, *Pittsburgh, PA*. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; www.ceramics.org.

17–18 9th Sampling, On-Site Analysis, and Sample Preparation Conf., *Pittsburgh, PA*. Professional Analytical and Consulting Services, Inc., 409 Meade Dr., Coraopolis, PA 15108-9616; 724-457-6576; e-mail HNPacs@aol.com; www.pacs-labs.com.

18–19 APS Ohio Section Fall Meeting, *Arlington, OH*. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

20–25 202nd Meeting of the Electrochemical Society, *Salt Lake City, UT*. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org.

21–24 8th Symposium on Temperature: Its Measurement and Control in Science and Industry, *Chicago, IL*. D. N. Dunkley, 8th Symposium on Temperature, ISA, P.O. Box 12277, 67 Alexander Dr., Research Triangle, NC 12277; e-mail ddunkley@isa.org.

24–26 2nd Intl. Conf. on Shaping of Advanced Ceramics, *Ghent, Belgium*. 32-14-335607; e-mail greet.meyen@vito.be.

28–29 ▼ Conf. on Geopolymers, *Melbourne, Australia*. H. Armitage, P.O. Box 2362, Richmond South, Victoria, 3121 Australia; fax 61-3-9855-0853; e-mail helen@geopolymer2002.com; www.geopolymer2002.com.

29–3 ABET Annual Meeting, *Pittsburgh, PA*. 2002 ABET Annual Meeting, 11 Market Place, Ste. 1050, Baltimore, MD 21202-4012; www.abet.org.

30–2 APS Southeast Section Meeting, *Auburn, AL*. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

NOVEMBER 2002

3–7 ▼ 28th Intl. Symposium for Testing and Failure Analysis, *Phoenix, AZ*. ASM Intl., 939639 Kinsman Rd., Materials Park, OH 44073-0002; 440-338-5151; fax 440-338-4634; e-mail cust-srv@asminternational.org; www.asminternational.org.

4–7 ▼ 34th Intl. SAMPE Technical Conf., *Baltimore, MD*. Society for the Advancement of Material and Process Engineering, 1161 Parkview Dr., Covina, CA 91724-3748; 626-331-0616; fax 626-332-8929; e-mail daunwhite@aol.com; www.sampe.org.

4-8 ▼ AVS 49th Intl. Symposium, *Denver, CO*. American Vacuum Society Natl. Office, 120 Wall St., 32nd Fl., New York, NY 10005; 212-248-0200; fax 212-248-0245; e-mail avsnyc@vacuum.org; www.avs.org.

5-7 14th IAS Rolling Conf., 1st IAS Conf. on Uses of Steel, and 4th ISS Argentina Section Meeting, *Buenos Aires, Argentina*. C. Genzano, Inst. Argentino de Siderurgia, Av. Central y Calle 19 Oeste, 2900 San Nicolás, Pcia. de Buenos Aires, Argentina; 54-3461-460803; fax 54-3461-462989; e-mail genzano.ias@cablenet.com.ar; www.cablenet.com.ar/ias/semlaminacion.htm.

6-8 ▼ ASTM Intl. Workshop on Galling Test Methods, *Miami Beach, FL*. ASTM Intl., 100 Barr Harbor Dr., West Conshohocken, PA 19428-2959; 610-832-9500; fax 610-832-9555; e-mail service@astm.org; www.astm.org.

10-14 AAPS Annual Meeting, *Toronto, Ontario, Canada*. American Assoc. of Pharmaceutical Scientists, 2107 Wilson Blvd., Ste. 700, Arlington, VA 22201-3046; 703-243-2800; fax 703-243-9532; e-mail meetings@aaps.org; www.aaps.org.

11-15 44th Annual Meeting of the APS Division of Plasma Physics, *Orlando, FL*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail meetings@aps.org; www.aps.org.

12-16 17th Intl. Conf. on the Application of Accelerators in Research and Industry, *Denton, TX*. J.L. Duggan, Univ. of North Texas, Denton, TX 76203-1427; 940-565-3250; fax 940-565-2227; e-mail jduggan@unt.edu; http://orgs.unt.edu/CAARI.

13-15 ▼ 5th Mechanical Components and Materials Technology Expo Kansai, *Osaka, Japan*. J.A. Go, M-Tech Show Mgmt Office; 81-3-3349-8506; fax 81-3-3345-7929; e-mail go@reedexpo.co.jp; www.reedexpo.co.jp/m-tech.

13-15 ▼ Organic Light Emitting Devices Conf., *San Diego, CA*. P. Kinzer, Conf. Director, Intertech Corp., 19 Northbrook Office Park, Portland, ME 04105; 207-781-9604; fax 207-781-2150; e-mail pkinzer@intertechusa.com; www.intertechusa.com.

20-21 Symposium in Memory of Dr. Bernie Miller, *Princeton, NJ*. Course Registrar, TRI/Princeton, 601 Prospect Ave., Princeton, NJ 08540; 609-430-4820; fax 609-683-7149; e-mail info@triprinceton.org; www.triprinceton.org/miller.

24-26 APS Division of Fluid Dynamics Meeting, *Dallas, TX*. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

DECEMBER 2002

2-6 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

7-11 EUCHEM Conf. on Molecular Tribology, *Märsta, Sweden*. Molecular Tribology, The Swedish Natl. Committee for Chemistry, Wallingatan 24 3tr, SE-111 24 Stockholm, Sweden; 46-8-411-52-60; fax 46-8-10-66-78; e-mail anna@chemsoc.se; www.chemsoc.se.

JANUARY 2003

6-8 ▼ 2nd North American Perpendicular Magnetic Recording Conf., and 6th Perpendicular Magnetic Recording Conf., *Monterey, CA*. fax 419-791-3337; e-mail info@napmrc.org; www.napmrc.org. **Endorsed.**

MARCH 2003

2-6 TMS Annual Meeting, *San Diego, CA*. Programming Dept., The Minerals, Metals & Materials Society, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail ckobert@tms.org.

31-3 Conf. on Microscopy of Semiconducting Materials, *Cambridge, UK*. The Inst. of Physics, 76 Portland Place, London W1B 1NT, UK; 44-207-470-4800; e-mail conferences@iop.org.

APRIL 2003

21-25 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

27-2 ▼ 14th European Conf. on Chemical Vapor Deposition, *Paris, France*. M. Swihart, 716-645-2911; fax 716-645-3822; e-mail swihart@eng.buffalo.edu.

JUNE 2003

9-13 E-MRS Spring Meeting, *Strasbourg, France*. E-MRS, 23 rue du Loess, B.P. 20, 67037 Strasbourg Cedex 02, France; 33-3-8810-6372; fax 33-3-8810-6343; e-mail emrs@phase.c-strasbourg.fr; www.emrs.c-strasbourg.fr. **E-MRS.**

29-4 16th Intl. Conf. on Ion Beam Analysis, *Albuquerque, NM*. B. Doyle, Sandia Natl. Laboratories, P.O. Box 5800, Albuquerque, NM 87185; 505-844-7568; fax 505-844-7775; e-mail bldoyle@sandia.gov. **Endorsed.**

JULY 2003

10-14 Thermec 2003 Intl. Conf., *Madrid, Spain*. T. Chandra, Faculty of Engineering, Univ. of Wollongong, Wollongong 2522, Australia; 61-242-213-008; fax 61-242-214-921.

13-18 ▼ 10th World Conf. on Titanium, *Hamburg, Germany*. P. von der Bey, DGM; fax 49-69-7917-733; www.ti-2003.dgm.de.

AUGUST 2003

24-27 ▼ 5th Intl. Symposium on Hydrometallurgy, *Vancouver, Canada*. C.G. Anderson; 406-496-4794.

31-5 16th Intl. Mass Spectrometry Society Conf., *Edinburgh, Scotland*. A. Upton, Secretary to the 16th IMSC Organizing Committee, Orchard House, 172 High Street Yelling, St. Neots, PE19 6SD, UK; 44-1480-88-0069; fax 44-1480-88-059; e-mail imscEdinburgh@btinternet.com; www.imsc-edinburgh2003.com.

SEPTEMBER 2003

22-26 ▼ Cryogenic Engineering Conf., and Intl. Cryogenic Materials Conf., *Anchorage, Alaska*. Centennial Conferences, 801 Main St., Ste. 010, Louisville, CO 80027; 303-499-2299; fax 303-499-2599; e-mail cec-icmc@centennialconferences.com; www.centennialconferences.com.

NOVEMBER 2003

3-8 ▼ 3rd Intl. Symposium on Slow Dynamics in Complex Systems, *Sendai, Japan*. M. Tokuyama, Inst. of Fluid Science, Tohoku Univ., 2-1-1 Katahira, Aoba-ku, Sendai 980-8577, Japan; phone and fax 81-22-217-5327; e-mail tokuyama@ifs.tohoku.ac.jp; www.ifs.tohoku.ac.jp/slow-dynamics/.

9-12 ▼ TMS Fall Meeting, *Chicago, IL*. TMS Meetings Services, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org.

DECEMBER 2003

1-5 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

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